



	LCB126	Units
Load Voltage	250	V
Load Current	170	mA
Max R _{ON}	15	Ω

Description

LCB126 is a 250V, 170mA, 15Ω 1-Form-B relay. It features enhanced peak load current capability and lower on-resistance.

Features

- Small 6 Pin DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 3750V_{RMS} Input/Output Isolation
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Version Available

Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- BSI Certified to:
 - BS EN 60950:1992 (BS7002:1992) Certificate #: 7344
 - BS EN 41003:1993 Certificate #: 7344

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hookswitch
 - Dial Pulsing
 - Ground Start
 - Ringer Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

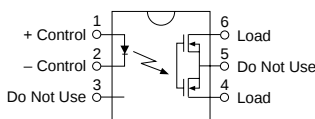
Ordering Information

Part #	Description
LCB126	6 Pin DIP (50/Tube)
LCB126S	6 Pin Surface Mount (50/Tube)
LCB126STR	6 Pin Surface Mount (1000/Reel)

Pin Configuration

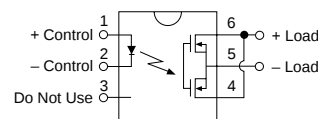
LCB126 Pinout

AC/DC Configuration

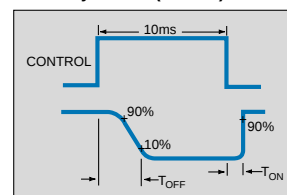


LCB126 Pinout

DC Only Configuration



Switching Characteristics of Normally Closed (Form B) Devices



Absolute Maximum Ratings (@ 25° C)

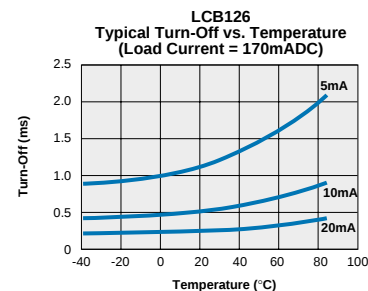
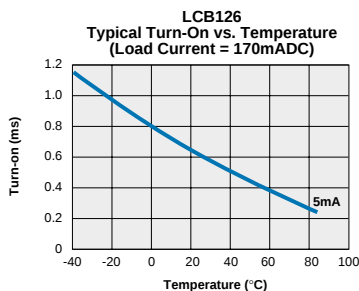
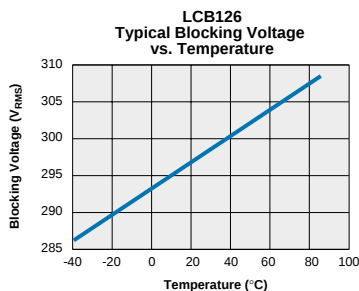
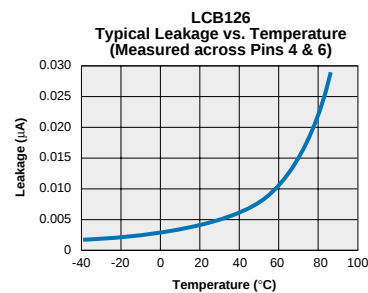
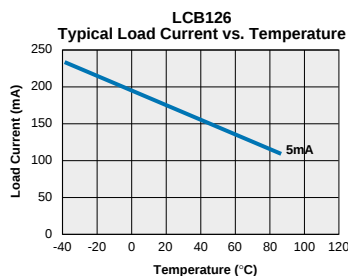
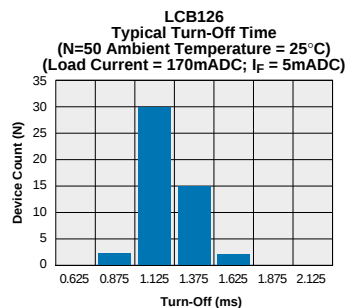
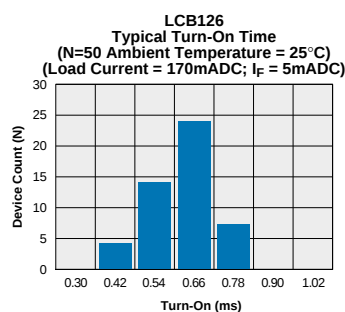
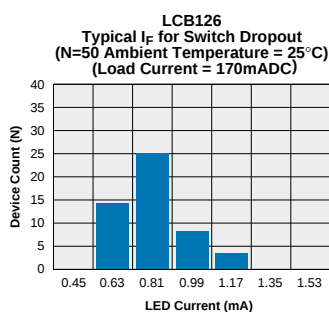
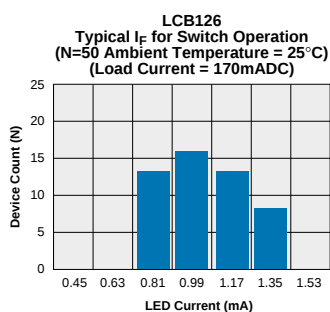
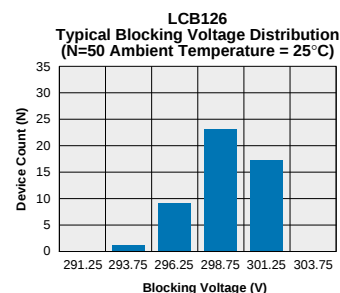
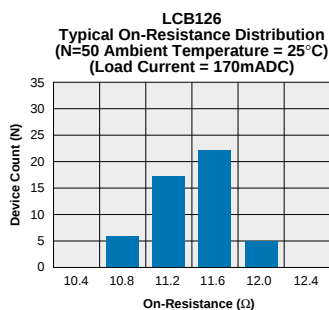
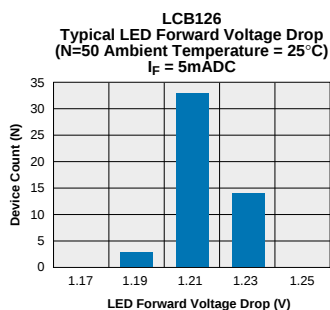
Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	150 ¹	mW
Input Control Current Peak (10ms)	-	-	50 1	mA A
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	800 ²	mW
Isolation Voltage Input to Output	3750	-	-	V _{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature DIP Package	-	-	+260	°C
Surface Mount Package (10 Seconds Max.)	-	-	+220	°C

¹ Derate Linearly 1.33 mW/°C² Derate Linearly 6.67 mW/°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

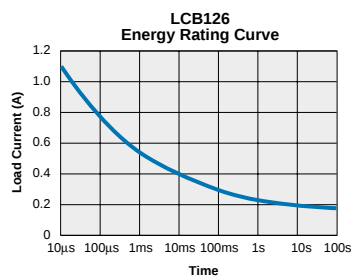
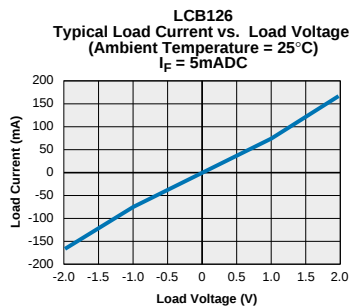
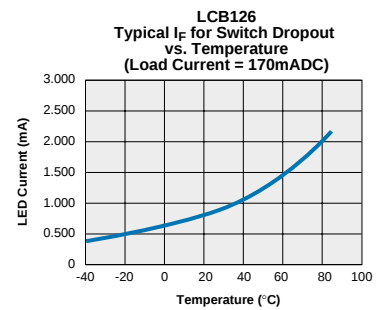
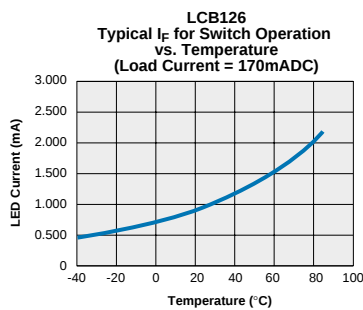
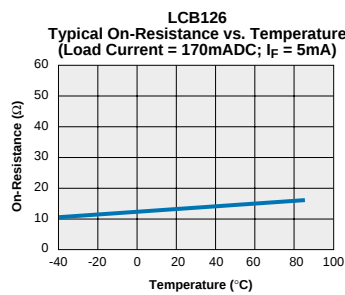
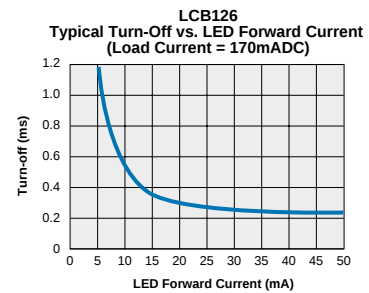
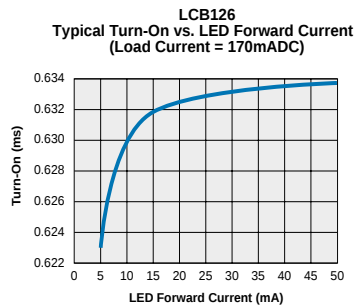
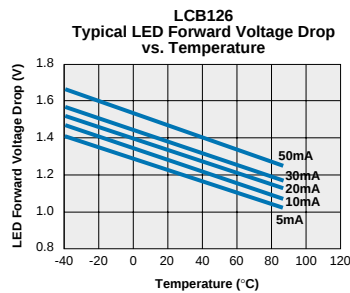
Electrical Characteristics

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS
Output Characteristics @ 25°C						
Load Voltage (Peak)	-	V _L	-	-	250	V
Load Current (Continuous)	-	I _L	-	-	170	mA
AC/DC Configuration	-	I _L	-	-	300	mA
DC Configuration	-	I _L	-	-	400	mA
Peak Load Current	10ms	I _L	-	-	400	mA
On-Resistance	-	R _{ON}	-	10	15	Ω
AC/DC Configuration	I _L =170mA	R _{ON}	-	4	5	Ω
DC Configuration	I _L =300mA	R _{ON}	-	-	1	μA
Off-State Leakage Current	V _L =250V	I _{LEAK}	-	-	1	μA
Switching Speeds	-	-	-	-	5	m
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	5	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	50	pF
Output Capacitance	50V; f=1MHz	C _{OUT}	-	50	-	pF
Capacitance	-	-	-	3	-	pF
Input to Output	-	-	-	-	-	pF
Input Characteristics @ 25°C						
Input Control Current	I _L =170mA	I _F	5	-	50	mA
Input Dropout Current	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	-	-	-	10	-	μA
Common Characteristics @ 25°C						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF
Input to Output Isolation	-	V _{I/O}	3750	-	-	V _{RMS}

PERFORMANCE DATA*


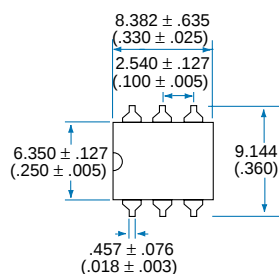
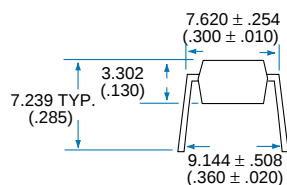
The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

6 Pin DIP Through Hole (Standard)



330.2 DIA.
(13.00)

Top Cover Tape Thickness
.102 MAX.
(.004)

6.731 MAX.
(.265)

406 MAX.
(.016)

12.090
(.476)

4.877
(.192)

7.493 ± .102
(.295 ± .004)

2.007 ± .102
(.079 ± .004)

1.498 ± .102
(.059 ± .004)

3.987 ± .102
(.157 ± .004)

16.002 ± .305
(.630 ± .012)

10.100
(.398)

11.989 ± .102
(.472 ± .004)

10.100 ± .102
(.398 ± .004)

1.549 ± .102
(.061 ± .004)

.050R TYP.

Embossed Carrier

Embossment

User Direction of Feed

Rev. 3



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